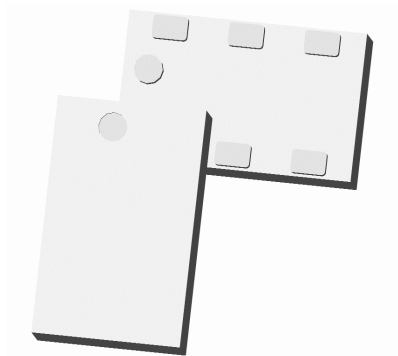




**Ultra Low Profile 0805 Balun
50Ω to 200Ω Balanced**

Description:

The BD3438J50200AHF is a low profile sub-miniature balanced to unbalanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount package. The BD3438J50200AHF is ideal for high volume manufacturing and is higher performance than traditional ceramic and lumped element baluns. The BD3438J50200AHF has an unbalanced port impedance of 50Ω and a 200Ω balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern semiconductors. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD3438J50200AHF is available on tape and reel for pick and place high volume manufacturing.



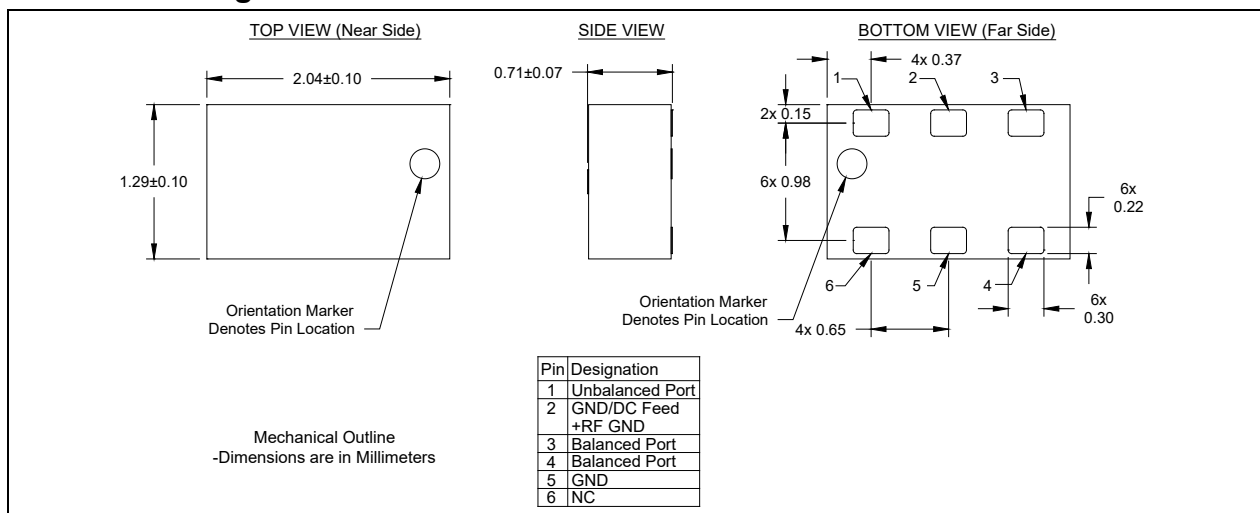
Detailed Electrical Specifications:

Features:	Parameter	ROOM (25°C)			ROOM (25°C)			Unit
		Min.	Typ.	Max	Min.	Typ.	Max	
<ul style="list-style-type: none"> • 2670 – 3470 MHz • 3400 – 3800 MHz • 0.7mm Height Profile • 50 Ohm to 2 x 100 Ohm • Low Insertion Loss • Input to Output DC Isolation • Surface Mountable • Tape & Reel • Non-conductive Surface • RoHS Compliant 	Frequency	2670		3470	3400		3800	MHz
	Unbalanced Port Impedance		50		50		200	Ω
	Balanced Port Impedance	10	14		11	15		Ω
	Return Loss		0.7	1.0	0.7	1.0		dB
	Insertion Loss		0.1	0.5	0.1	0.6		dB
	Amplitude Balance		4	10	4	10		Degrees
	Phase Balance		30		29			dB
	CMRR			2		2		Watts
	Power Handling @85C		-55	+105	-55	+105		°C
	Power Handling @105C							
	Operating Temperature							

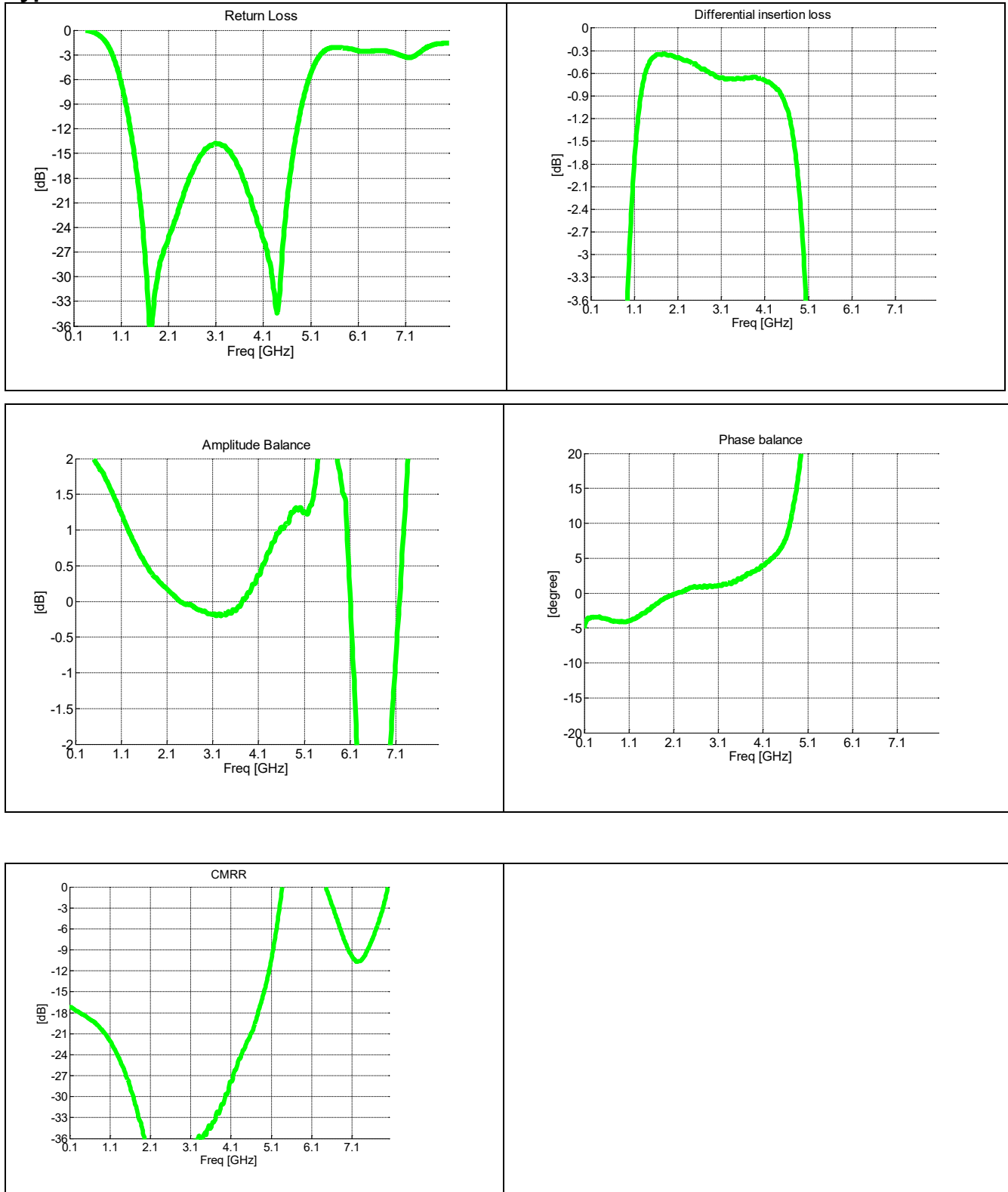
Specification subject to change without notice.

*Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

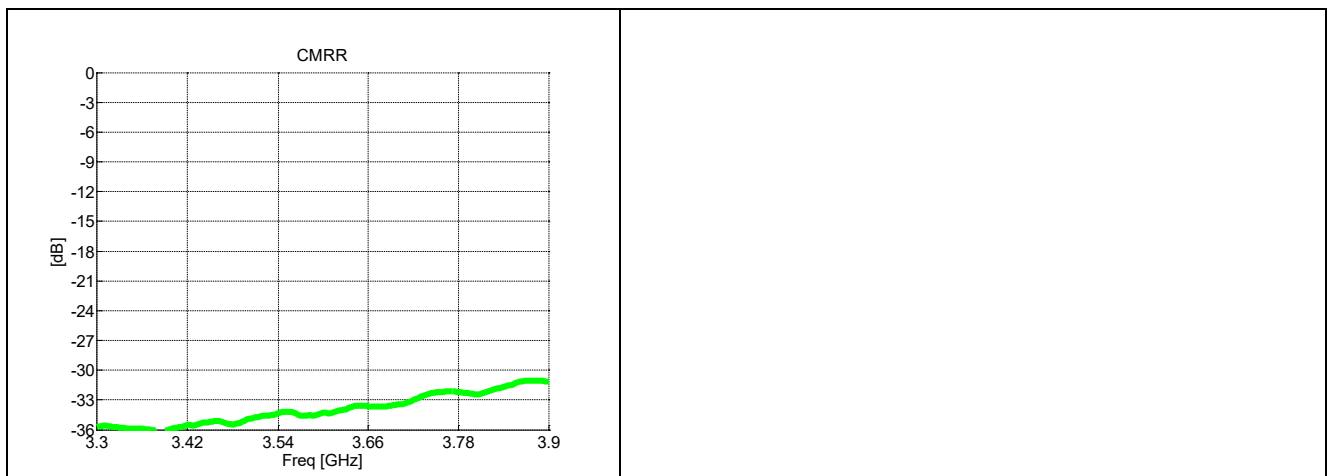
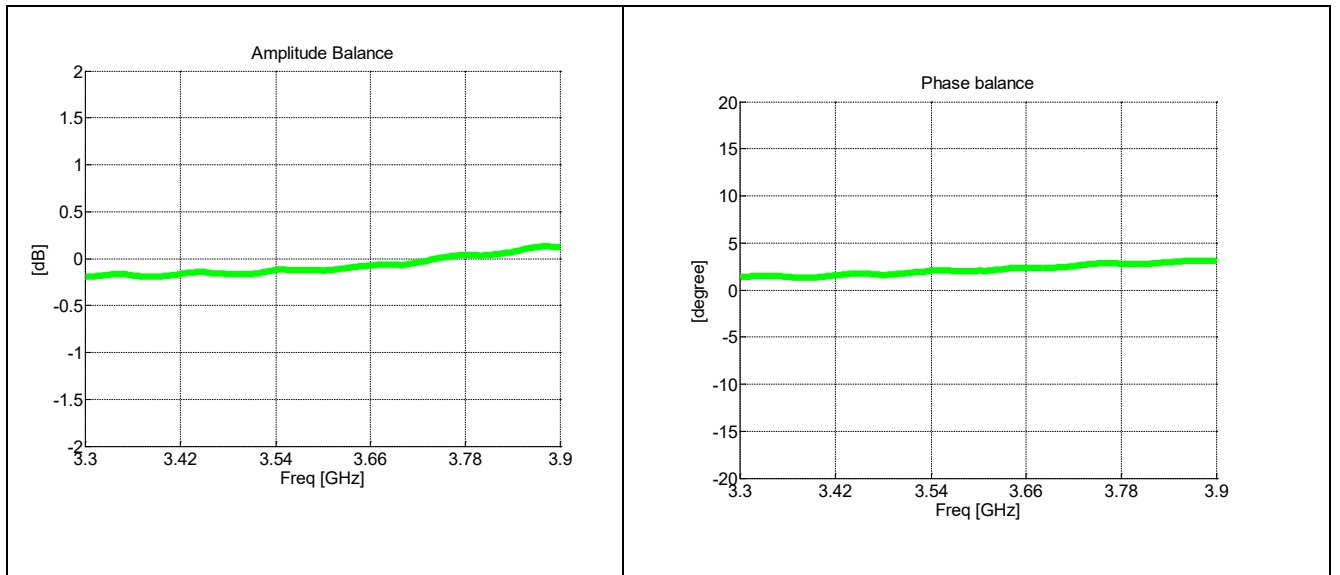
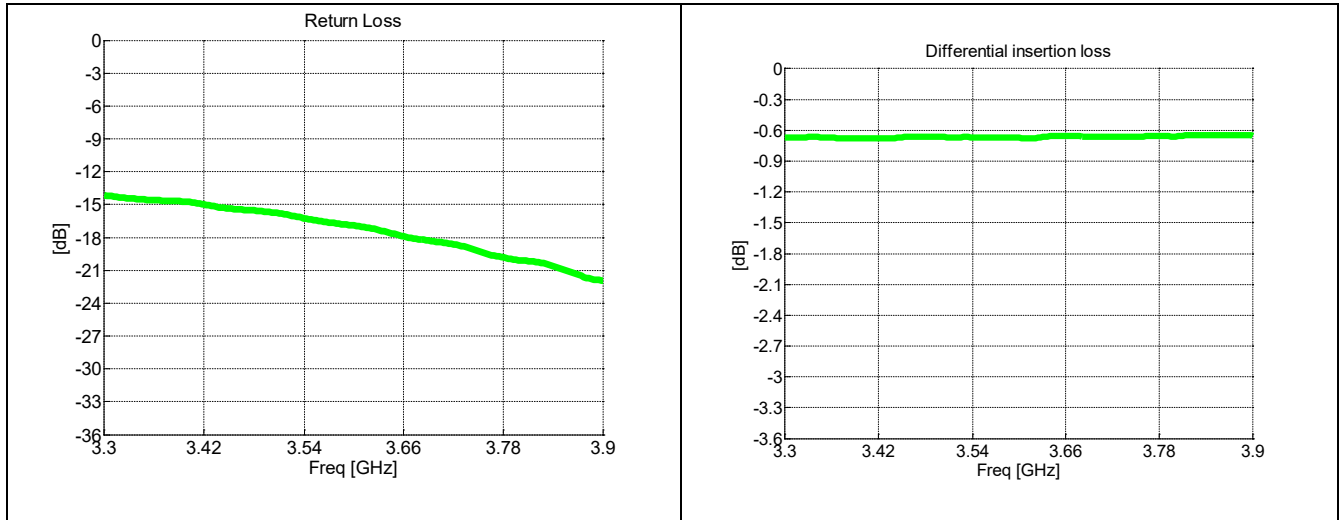
Outline Drawing:



Typical Performance: 10MHz to 8.0GHz



Wide Band Performance: 3300MHz to 3900MHz

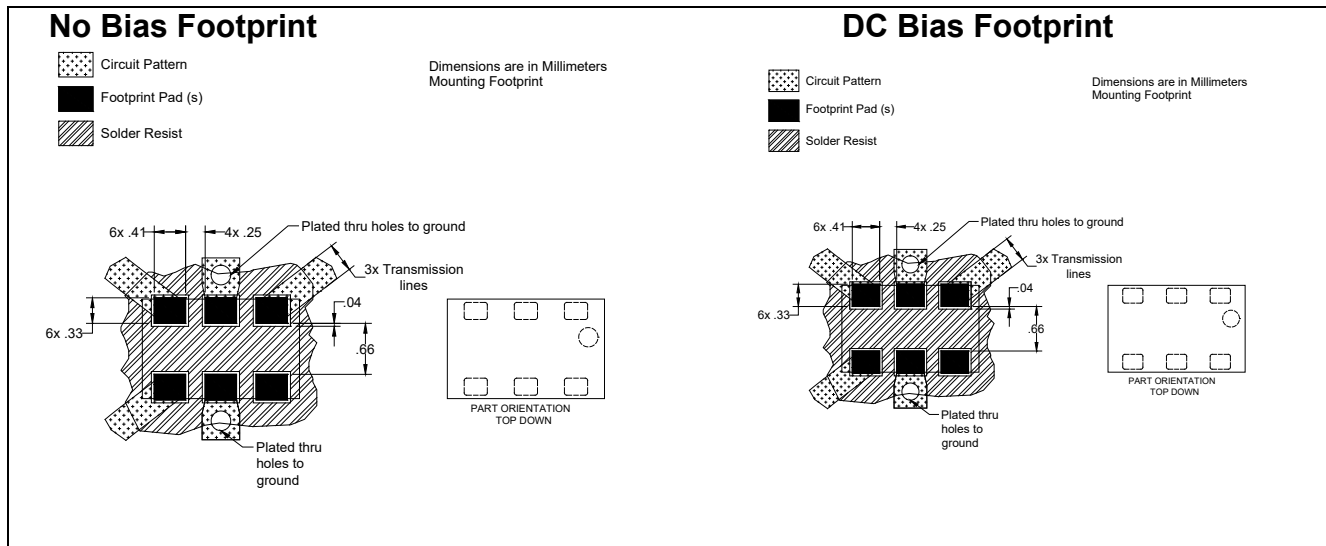


Mounting Configuration:

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, isolation and VSWR may not meet published specifications.

All of the Xinger components are constructed from organic PTFE based composites which possess excellent electrical and mechanical stability. Xinger components are compliant to a variety of ROHS and Green standards and ready for Pb-free soldering processes. Pads are Gold plated with a Nickel barrier.

An example of the PCB footprint used in the testing of these parts is shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thickness as well as varying pick and place equipment tolerances.



Packaging and Ordering Information:

Parts are available in reel and are packaged per A 481-D. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel.

